Optimum power handling
Low on-state and switching losses
Designed for traction and industrial applications

Phase Control Stud Thyristor
Type T471-250-18

Mean on-state current							I_{TAV}			250 A							
Repetitive peak off-state voltage							V_{DRM}			100...1800 V							
Repetitive peak reverse voltage							V_{RRM}										
Turn-off time							t_q			125, 160, 200, 250, 320, 400, 500 µs							
V_{DRM}, V_{RRM}, V	100	200	300	400	500	600	700	800	900	1000	1100	1200	1300	1400	1500	1600	1800
Voltage code	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	18
T_j, °C	–60...+125																

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Maximum allowable mean on-state current	A	250 307	T_c= 94 °C; T_c= 85 °C; 180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current	A	393	T_c= 94 °C; 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current	kA	6.5 7.5	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=10 ms; single pulse; V_D=V_R=0 V; Gate pulse: I_G=2 A; t_{GP}=50 µs; di_G/dt≥1 A/µs
			7.0 8.0	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=8.3 ms; single pulse; V_D=V_R=0 V; Gate pulse: I_G=2 A; t_{GP}=50 µs; di_G/dt≥1 A/µs
I^2t	Safety factor	$A^2s{\cdot}10^3$	210 280	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=10 ms; single pulse; V_D=V_R=0 V; Gate pulse: I_G=2 A; t_{GP}=50 µs; di_G/dt≥1 A/µs
			200 260	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=8.3 ms; single pulse; V_D=V_R=0 V; Gate pulse: I_G=2 A; t_{GP}=50 µs; di_G/dt≥1 A/µs
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	100...1800	$T_{j\,min}$< T_j <$T_{j\,max}$; 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	200...1900	$T_{j\,min}$< T_j <$T_{j\,max}$; 180° half-sine wave; single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	0.6·V_{DRM} 0.6·V_{RRM}	T_j=$T_{j\,max}$; Gate open	

TRIGGERING				
I_{FGM}	Peak forward gate current	A	6	$T_j=T_{j\,max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	3	$T_j=T_{j\,max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/µs	1000	$T_j=T_{j\,max}$; $V_D=0.67\cdot V_{DRM}$; I_{TM}=1700 A; Gate pulse: I_G=2 A; t_{GP}=50 µs; $di_G/dt\geq 2$ A/µs
THERMAL				
T_{stg}	Storage temperature	°C	–60...+50	
T_j	Operating junction temperature	°C	–60...+125	
MECHANICAL				
M	Tightening torque	Nm	25...35	
a	Acceleration	m/s^2	100	

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage, max	V	1.55	T_j=25 °C; I_{TM}=785 A	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.036	$T_j=T_{j\,max}$; $0.5\,\pi\,I_{TAV} < I_T < 1.5\,\pi\,I_{TAV}$	
r_T	On-state slope resistance, max	mΩ	0.653		
I_L	Latching current, max	mA	700	T_j=25 °C; V_D=12 V; Gate pulse: I_G=2 A; t_{GP}=50 µs; $di_G/dt\geq 1$ A/µs	
I_H	Holding current, max	mA	300	T_j=25 °C; V_D=12 V; Gate open	
BLOCKING					
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	70	$T_j=T_{j\,max}$; $V_D=V_{DRM}$; $V_R=V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage[1)], min	V/µs	200, 320, 500, 1000	$T_j=T_{j\,max}$; $V_D=0.67\cdot V_{DRM}$; Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j=T_{j\,min}$ T_j=25 °C $T_j=T_{j\,max}$	V_D=12 V; I_D=3 A; Direct gate current
I_{GT}	Gate trigger direct current, max	mA	400 250 150	$T_j=T_{j\,min}$ T_j= 25 °C $T_j=T_{j\,max}$	
V_{GD}	Gate non-trigger direct voltage, min	V	0.60	$T_j=T_{j\,max}$; $V_D=0.67\cdot V_{DRM}$; Direct gate current	
I_{GD}	Gate non-trigger direct current, min	mA	35.00		
SWITCHING					
t_{gd}	Delay time, max	µs	1.25	T_j=25 °C; V_D=1000 V; $I_{TM}=I_{TAV}$; di/dt=200 A/µs; Gate pulse: I_G=2 A; V_G=20 V; t_{GP}=50 µs; di_G/dt=2 A/µs	
t_{gt}	Turn-on time, max	µs	4.00		
t_q	Turn-off time[2)], max	µs	125, 160, 200, 250, 320, 400, 500	dv_D/dt=50 V/µs; $T_j=T_{j\,max}$; $I_{TM}=I_{TAV}$; di_R/dt=-10 A/µs; V_R=100V; $V_D=0.67\cdot V_{DRM}$	
Q_{rr}	Recovered charge, max	µC	1100	$T_j=T_{j\,max}$; I_{TM}=250 A; di_R/dt=-10 A/µs; V_R=100 V	
t_{rr}	Reverse recovery time, max	µs	20		
I_{rr}	Reverse recovery current, max	A	110		

THERMAL				
R_{thjc}	Thermal resistance, junction to case, max	°C/W	0.0850	Direct current
MECHANICAL				
m	Weight, max	g	450	
D_s	Surface creepage distance	mm (inch)	12.40 (4.882)	
D_a	Air strike distance	mm (inch)	12.40 (4.882)	

PART NUMBERING GUIDE

T	471	250	18	A2	E2	N
1	2	3	4	5	6	7

1. Phase Control Thyristor
2. Design version
3. Mean on-state current, A
4. Voltage code
5. Critical rate of rise of off-state voltage, V/μs
6. Turn-off time (dv_D/dt=50 V/μs)
7. Ambient conditions: N – normal; T – tropical

NOTES

[1] Critical rate of rise of off-state voltage

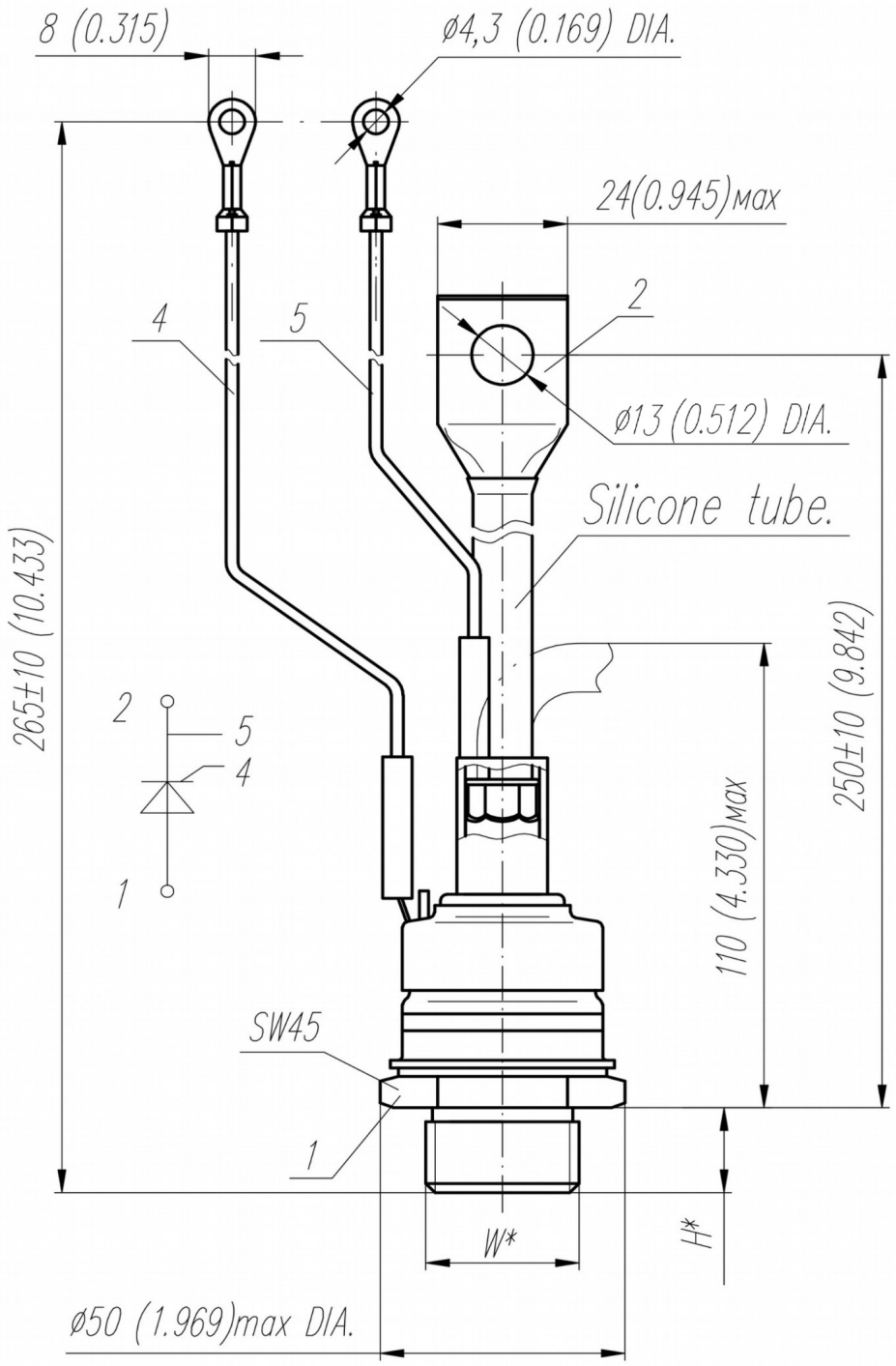
Symbol of Group	P2	K2	E2	A2
$(dv_D/dt)_{crit}$, V/μs	200	320	500	1000

[2] Turn-off time (dv_D/dt=50 V/μs)

Symbol of Group	X2	T2	P2	M2	K2	H2	E2
t_q, μs	125	160	200	250	320	400	500

OVERALL DIMENSIONS

Package type: T.SB2



Type of screw	W	H
Metric Screw Type C	M24x1,5 – 8g	19
Metric Screw Type B (upon request)	M20x1,5 – 8g	15

Polarity	Example of code designation	Reference designation	Colors		
			Anode	Cathode	Gate
Anode to stud	T471-250-18		-	Red tube	White

All dimensions in millimeters (inches)

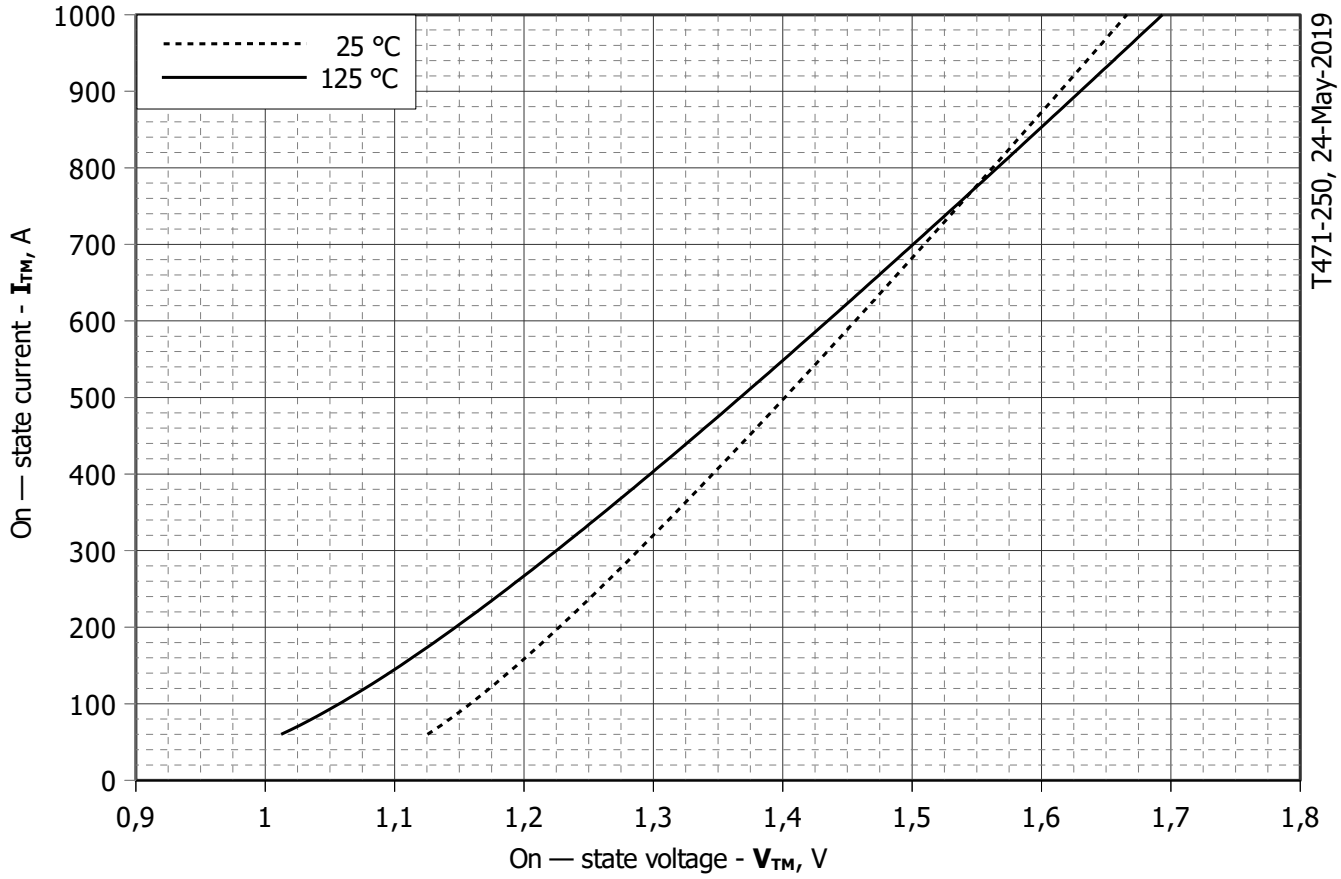


Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	T_j = 25°C	$T_j = T_{j\,max}$
A	1.00310000	0.82568000
B	0.00045769	0.00054987
C	0.01841200	0.03130700
D	0.00246890	0.00321650

On-state characteristic model (see Fig. 1)

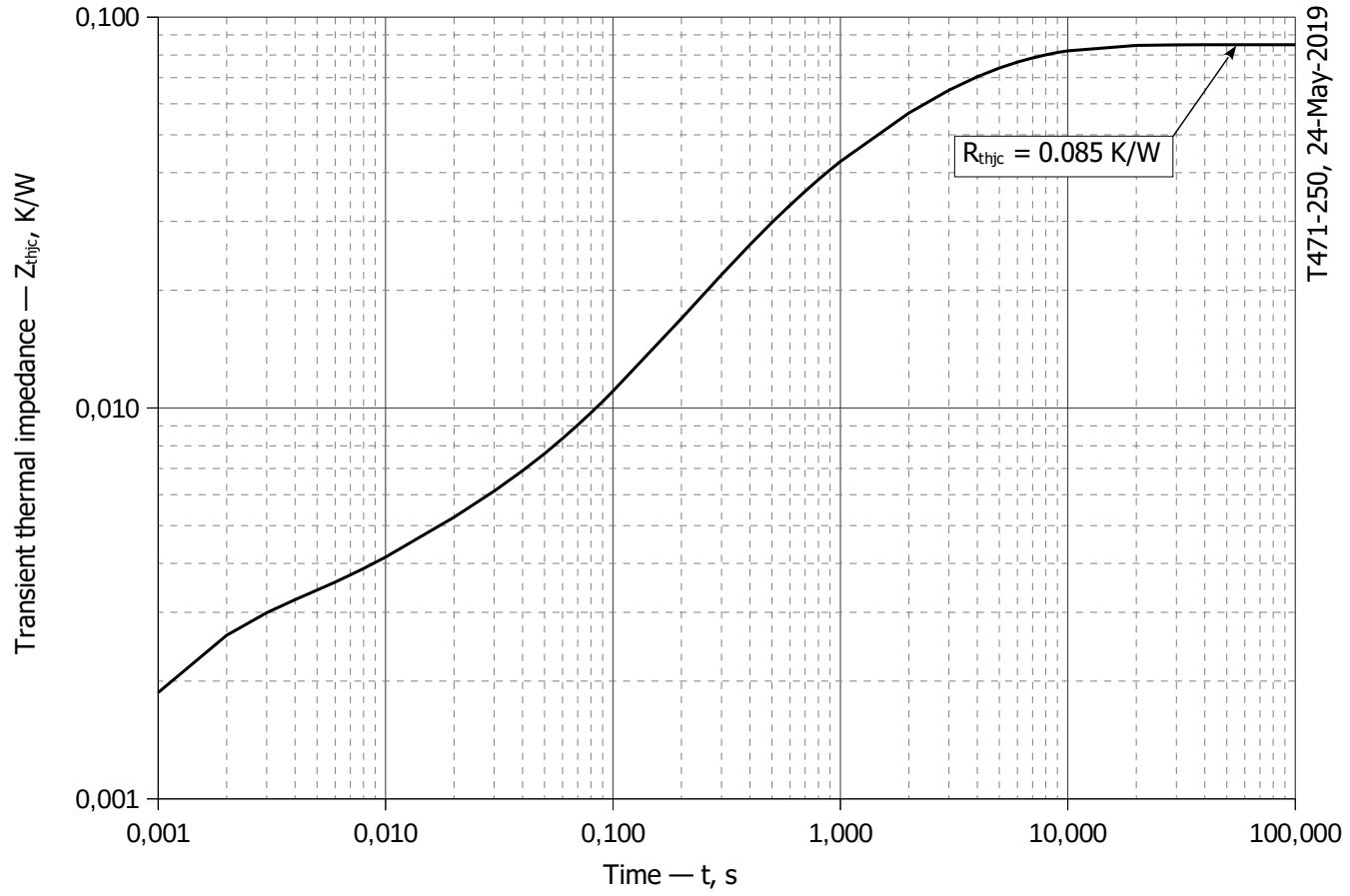


Fig 2 – Transient thermal impedance Z_{thjc} vs. time t

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^{n} R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where ***i*** = 1 to ***n***, ***n*** is the number of terms in the series.

t = Duration of heating pulse in seconds.

$\mathbf{Z_{thjc}}$ = Thermal resistance at time t.

$\mathbf{R_i}$ = Amplitude of p_{th} term.

$\boldsymbol{\tau_i}$ = Time constatnt of r_{th} term.

DC

i	1	2	3	4	5	6
$\mathbf{R_i}$, **K/W**	0.023357	0.02733	0.01495	0.001445	0.002488	0.01543
$\boldsymbol{\tau_i}$, **s**	4.627	2.249	0.3406	0.01043	0.0009112	0.9081

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

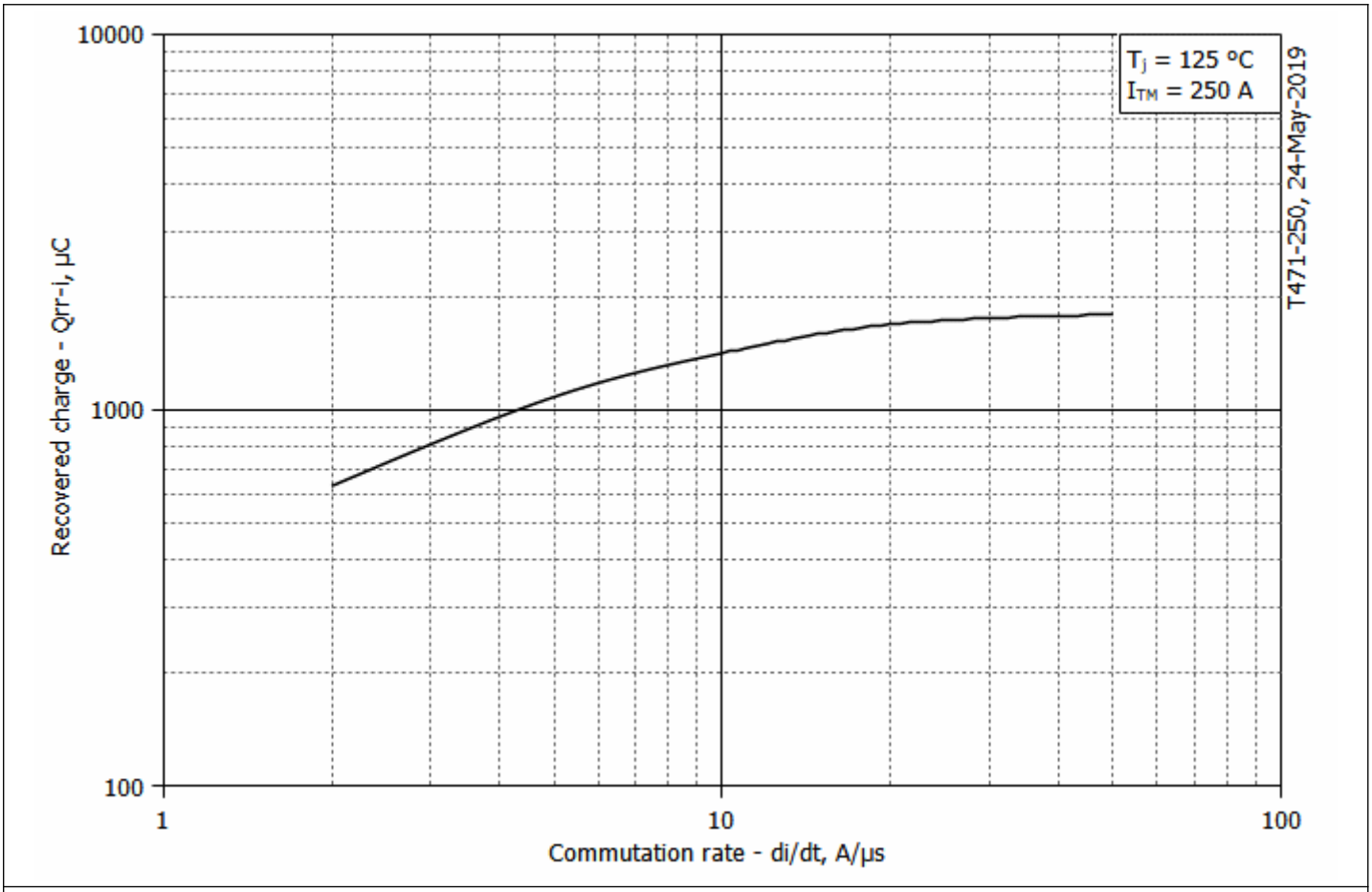


Fig 3 – Maximum recovered charge Q_{rr-i} (integral) vs. commutation rate di_R/dt

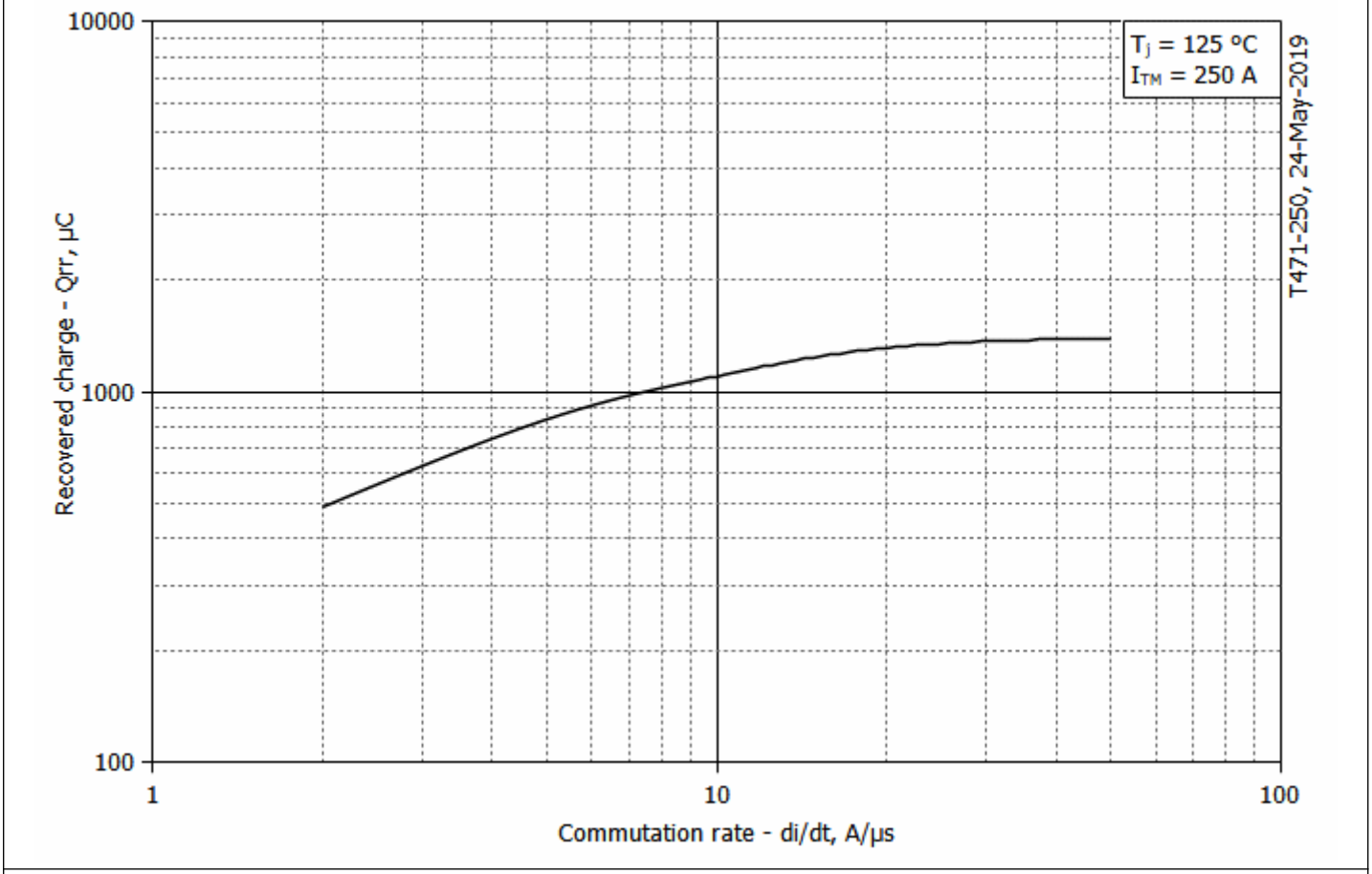


Fig 4 – Maximum recovered charge Q_{rr} vs. commutation rate di_R/dt (25% chord)

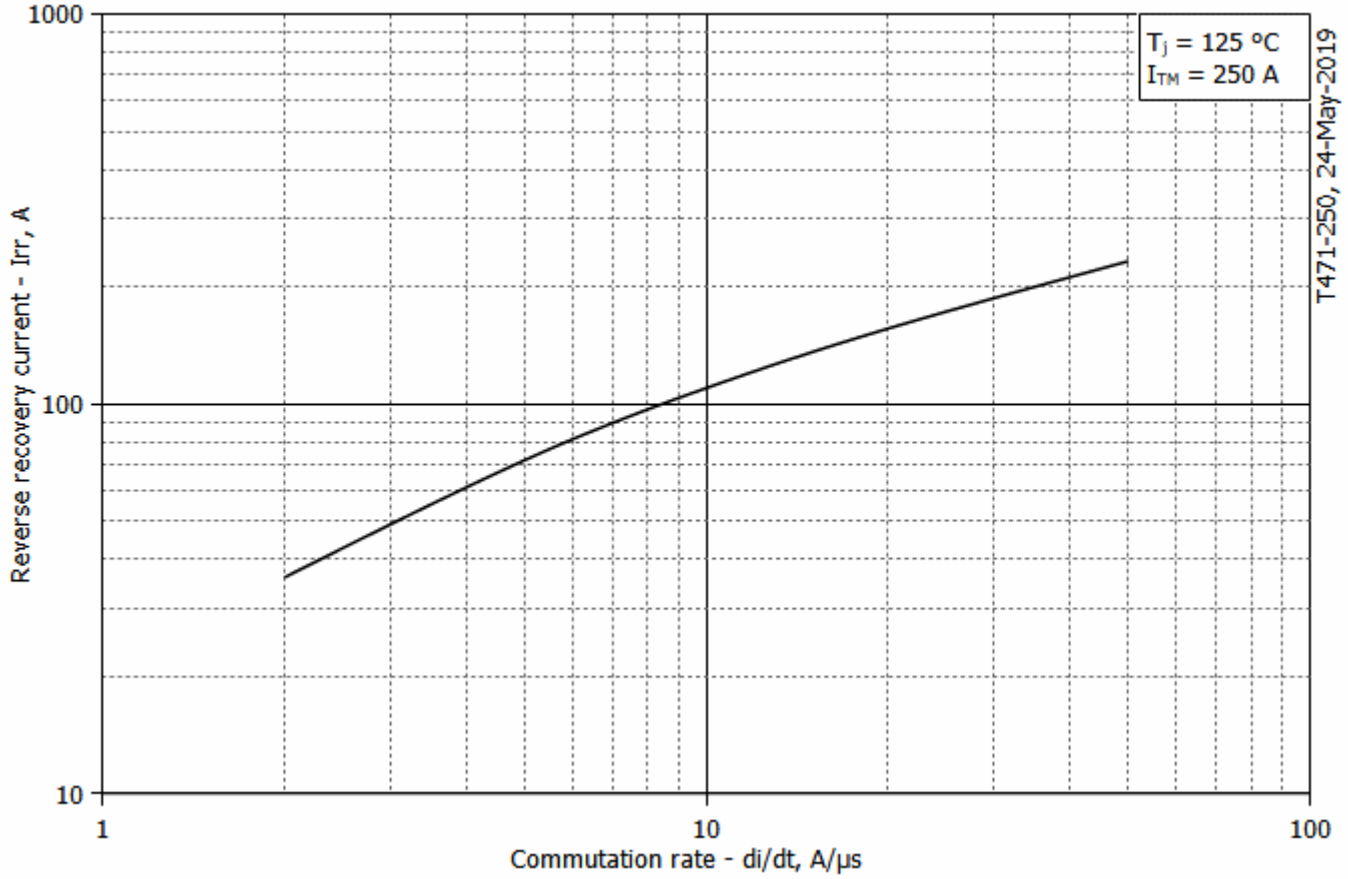


Fig 5 – Maximum reverse recovery current I_{rr} vs. commutation rate di_R/dt

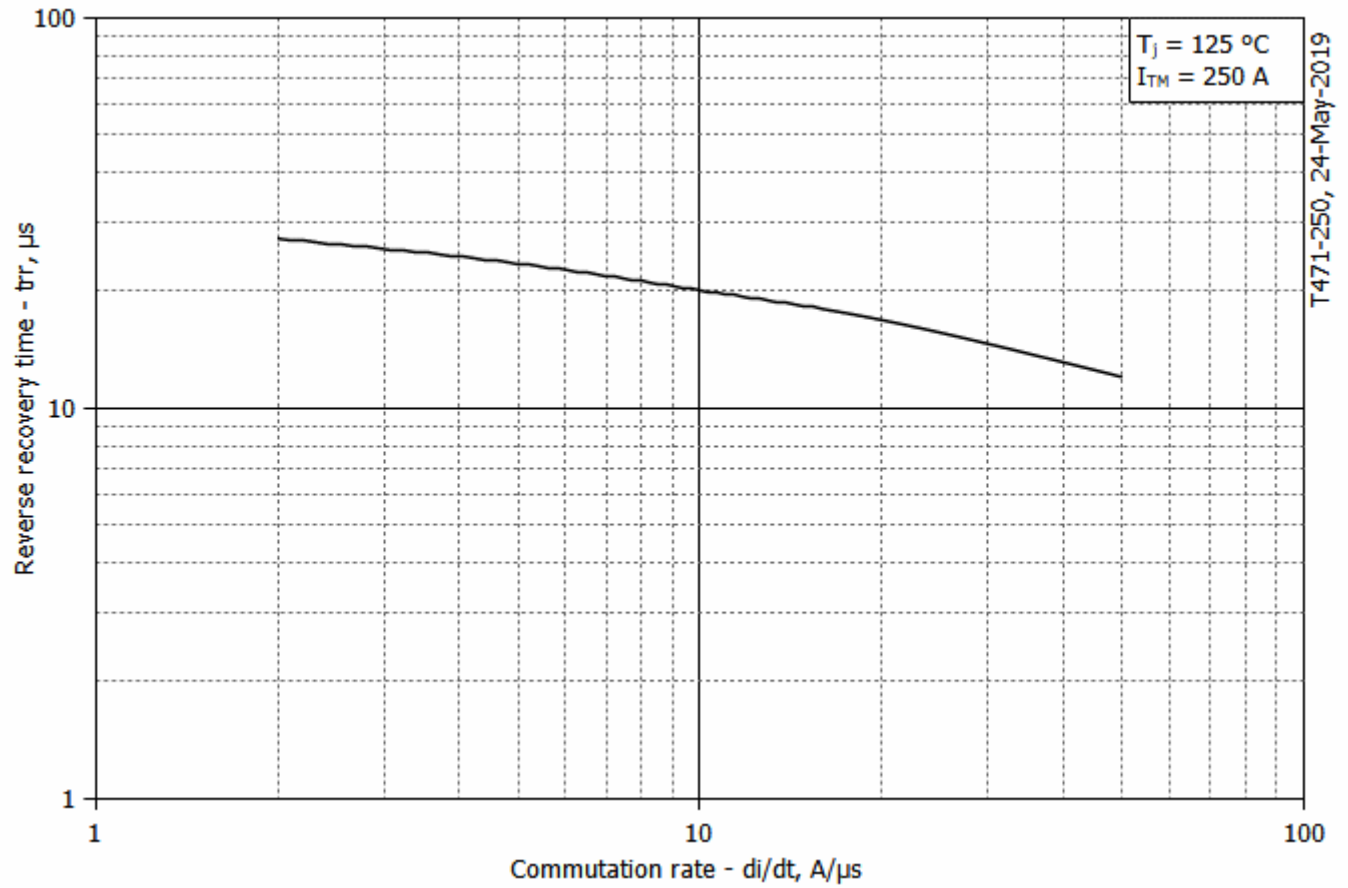


Fig 6 – Maximum recovery time t_{rr} vs. commutation rate di_R/dt (25% chord)

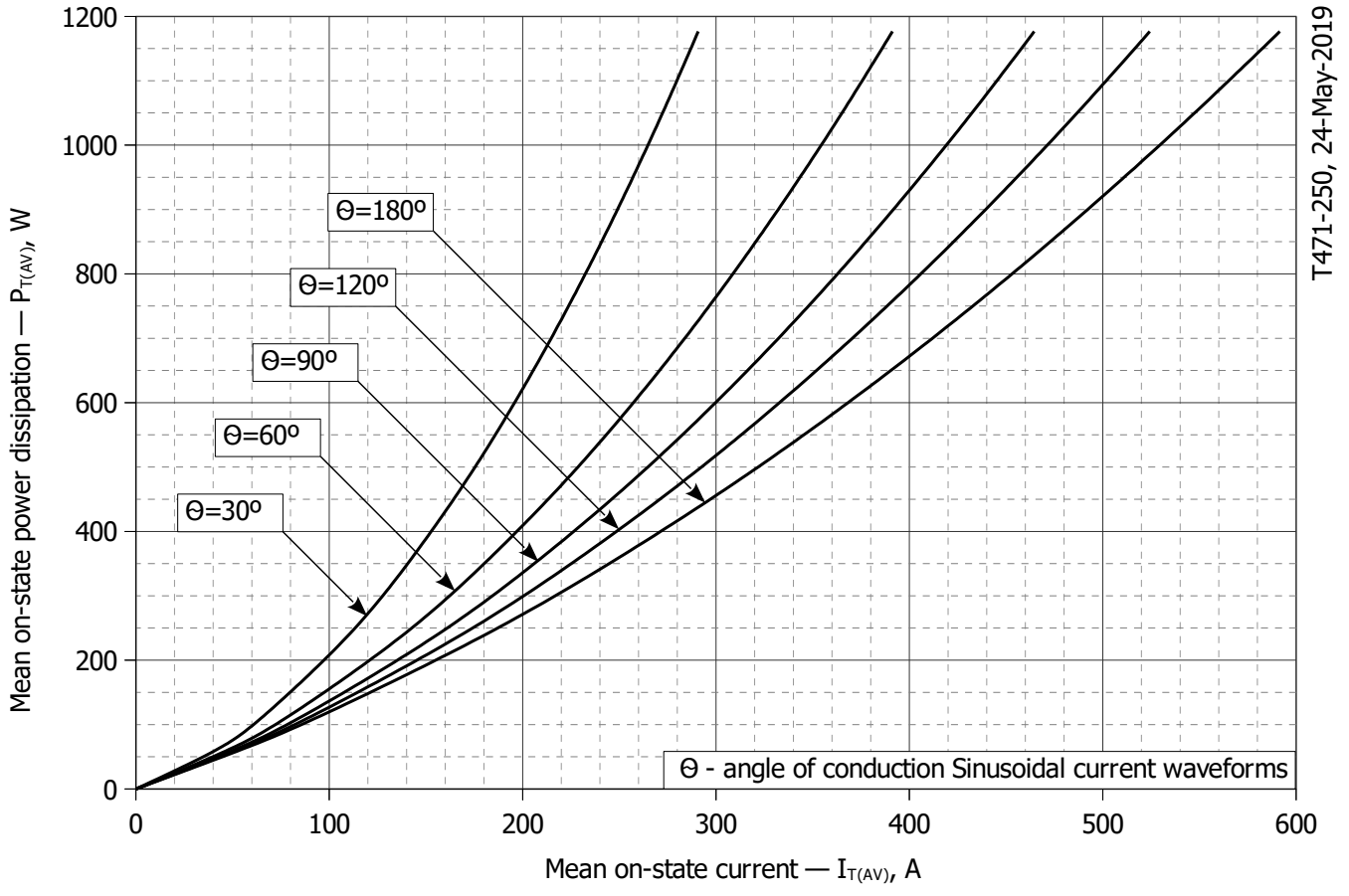


Fig. 7 - Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for sinusoidal current waveforms at different conduction angles (f=50Hz)

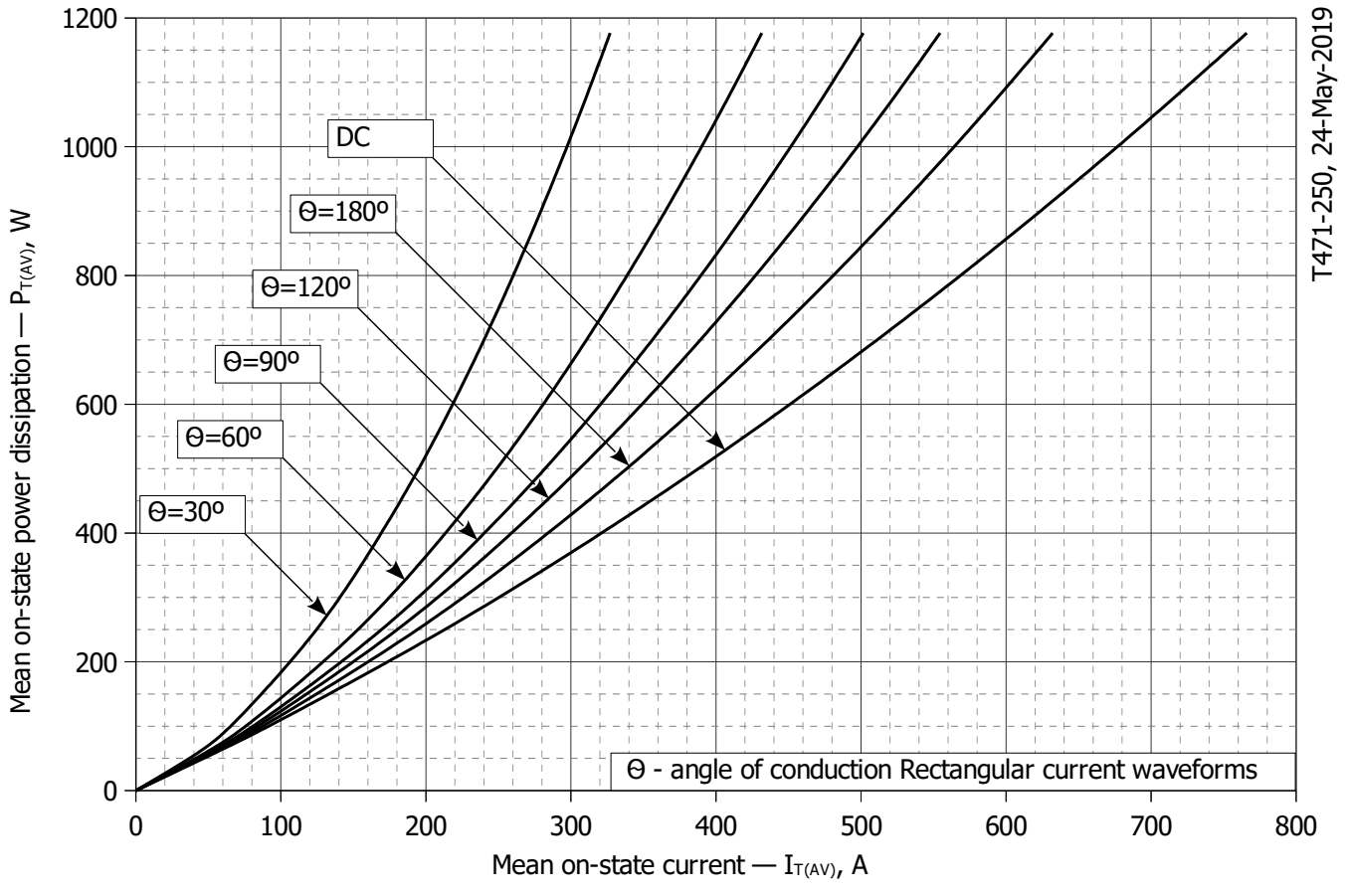


Fig. 8 – Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for rectangular current waveforms at different conduction angles and for DC (f=50Hz)

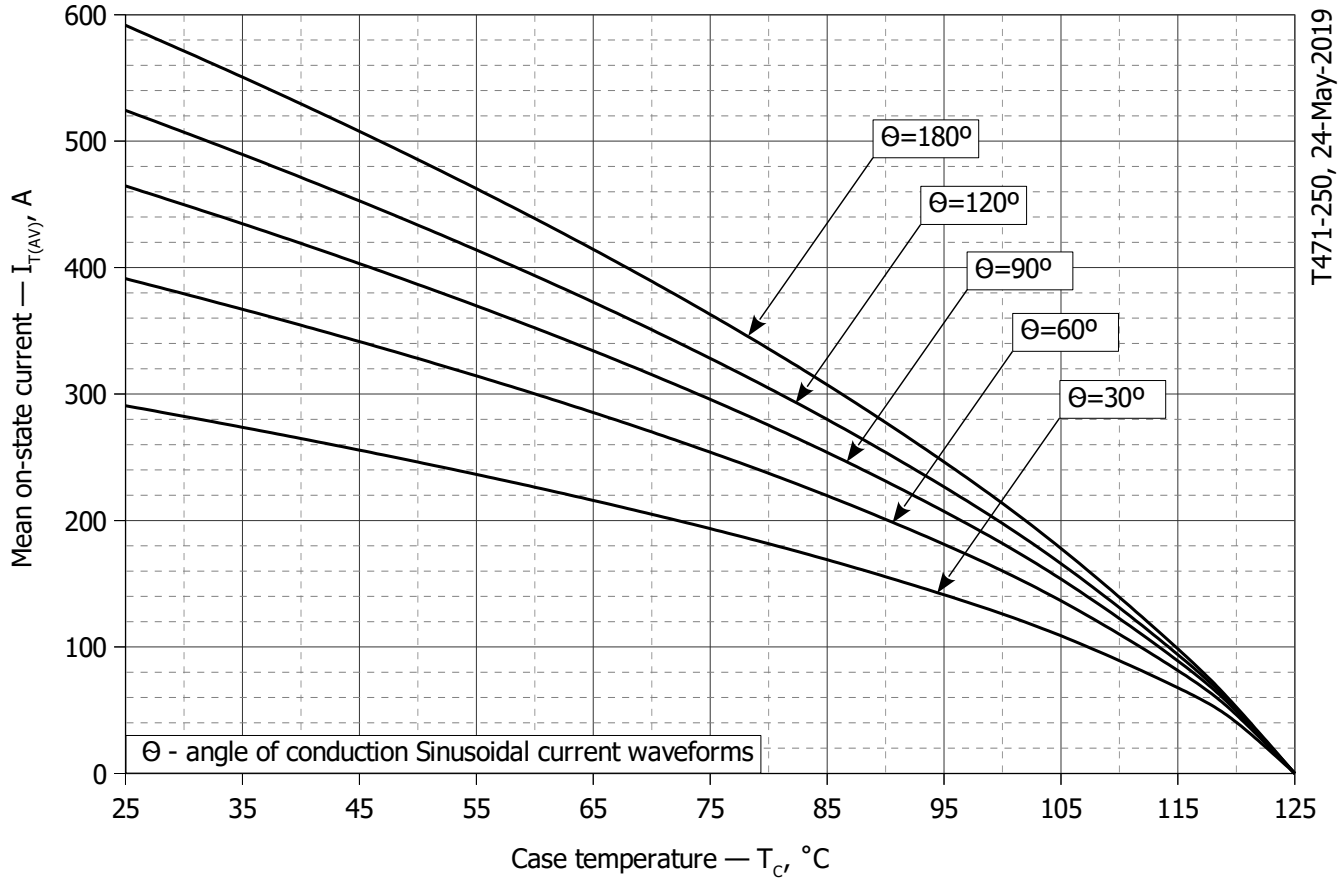


Fig. 9 – Mean on-state current I_{TAV} vs. case temperature T_C for sinusoidal current waveforms at different conduction angles (f=50Hz)

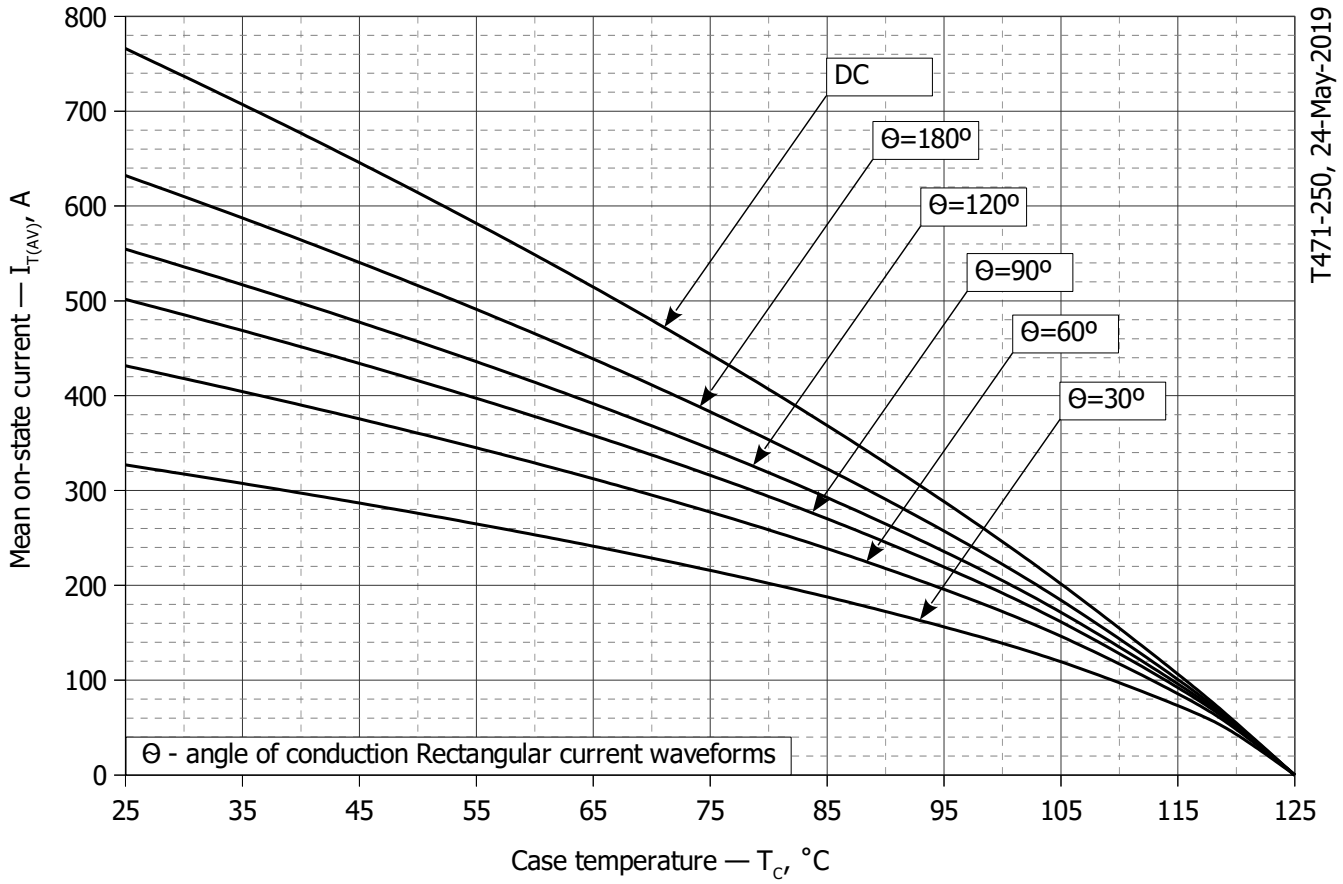


Fig. 10 - Mean on-state current I_{TAV} vs. case temperature T_C for rectangular current waveforms at different conduction angles and for DC (f=50Hz)

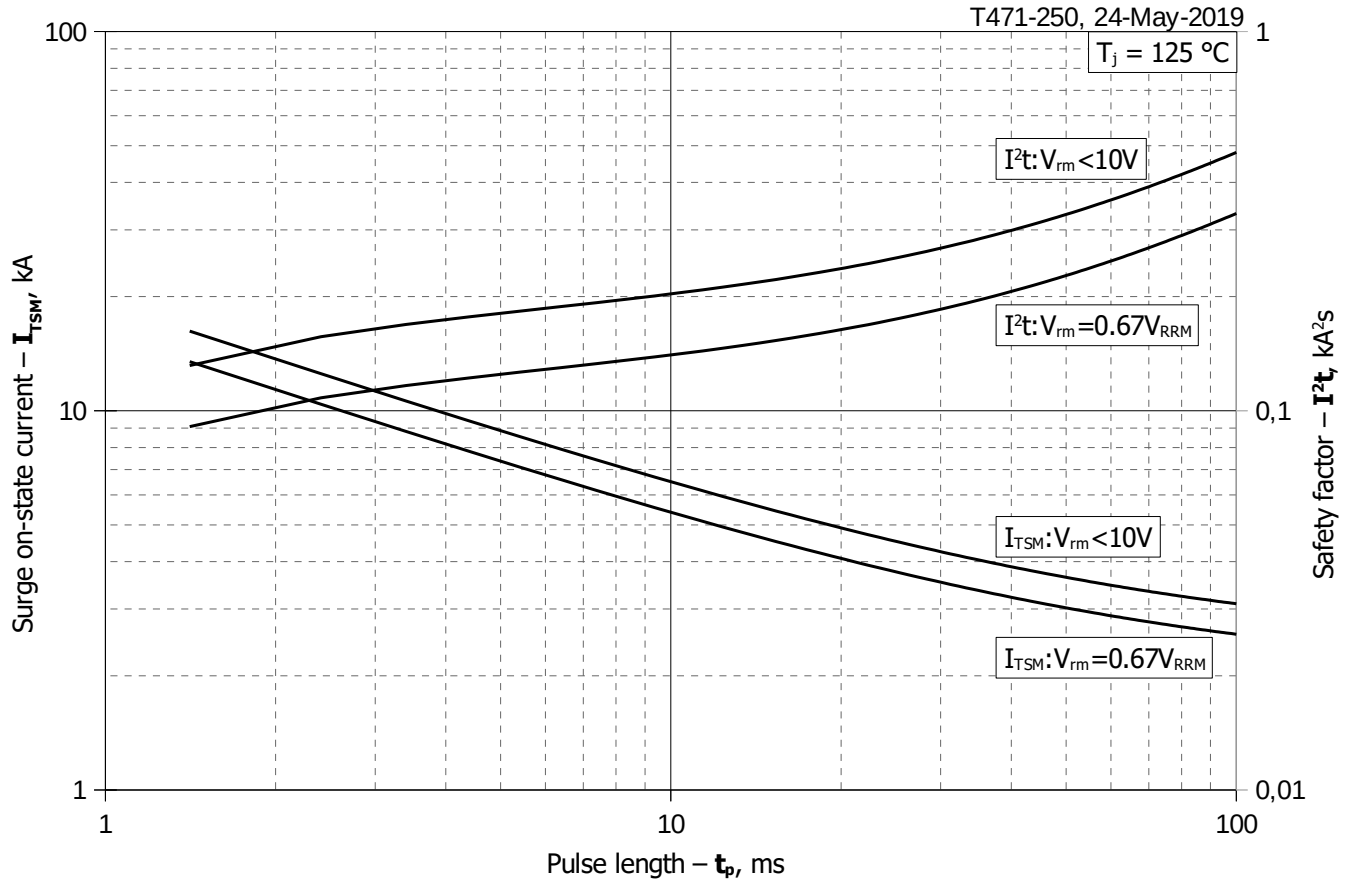


Fig. 11 – Maximum surge on-state current I_{TSM} and safety factor I^2t vs. pulse length t_p

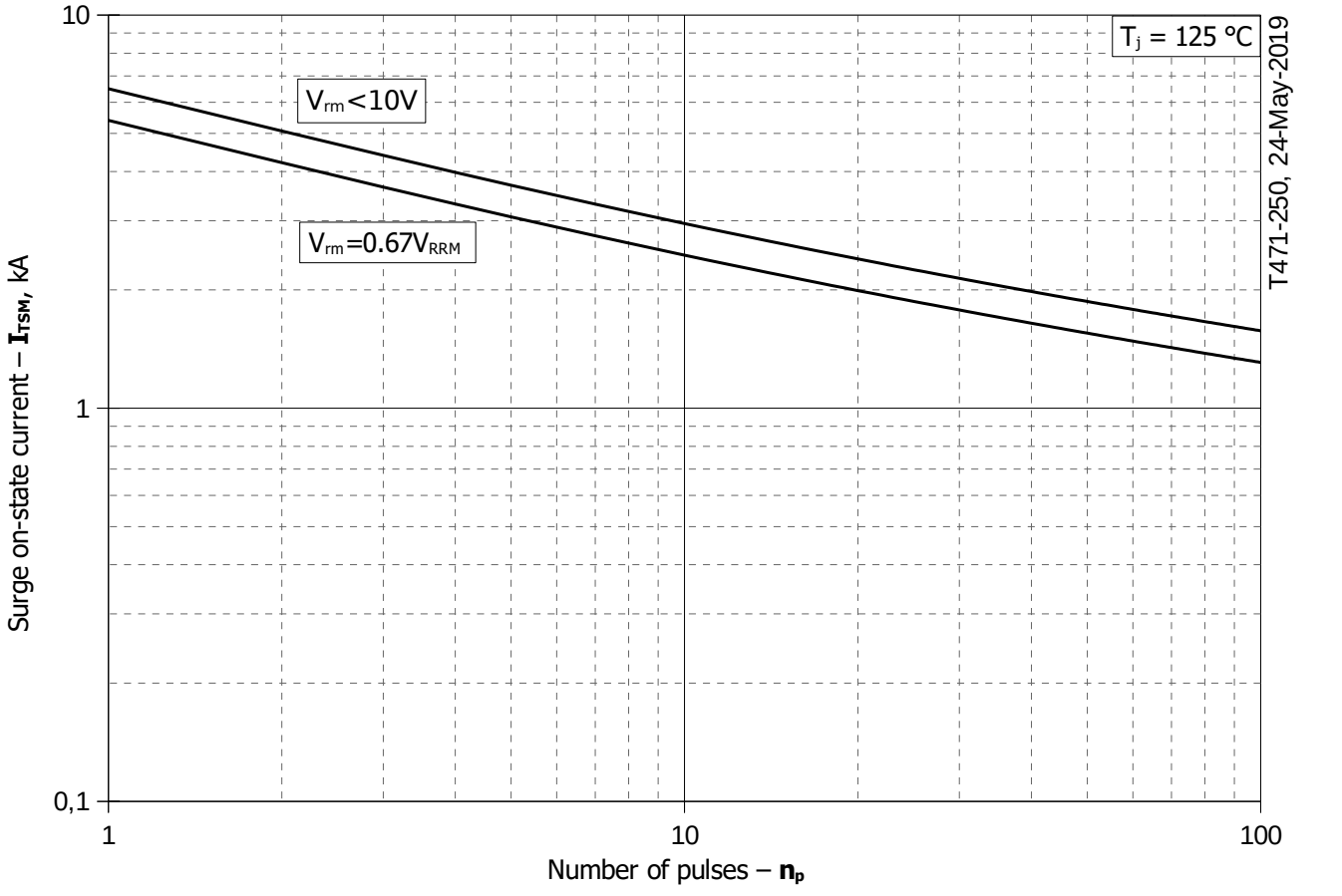


Fig. 12 - Maximum surge on-state current I_{TSM} vs. number of pulses n_p